

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Timothy A. Lemke	01/16/2009
RECEIVING PARTY DATA	
Name:	Z-Plane, Inc.
Street Address:	1170 Hamilton Avenue
City:	Palo Alto
State/Country:	CALIFORNIA
Postal Code:	94301
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12646817
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	012425-0004-999
NAME OF SUBMITTER:	James W. Peterson
Total Attachments: 1 source=Assignment_ZPlane_4#page1.tif	

CH \$40.00 12646817

ASSIGNMENT

WHEREAS, I, **TIMOTHY A. LEMKE**, ASSIGNOR, a citizen of the United States of America, residing at 130 Spring Drive, Dillsburg, Pennsylvania 17019, am the inventor of the invention in **INTERCONNECTION ASSEMBLY FOR PRINTED CIRCUIT BOARDS** for which I have executed an application for a Patent of the United States

- which is executed on even date herewith or
 which is identified by Jones Day docket no. 711476-999002
 which was filed on October 17, 2008, Application No. 12/288,209
 I hereby authorize and request attorney(s), at Jones Day, to insert here in parentheses (Application number, _____ filed _____) the filing date and application number of said application when known.

and WHEREAS, **Z-PLANE, INC.**, a California corporation doing business at 1170 Hamilton Avenue, Palo Alto, California 94301, ASSIGNEE, is desirous of obtaining my entire right, title and interest in, to and under the said invention and the said application:

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to me in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, I, the said ASSIGNOR, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, my entire right, title and interest in, to and under the said invention, and the said United States application and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said United States application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof;

AND I HEREBY authorize and request the Commissioner for Patents and any Official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I HEREBY covenant and agree that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

AND I HEREBY further covenant and agree that I will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries.

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this 16th day of January, 2009.


 TIMOTHY A. LEMKE

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RECORDED: 12/28/2009

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